

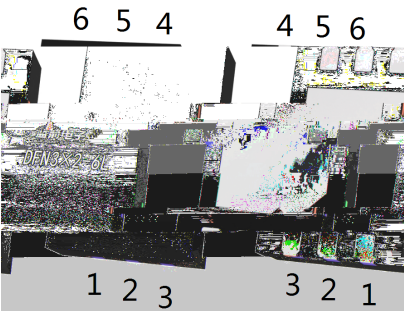
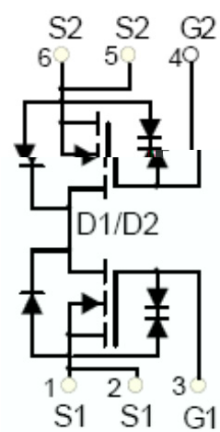
DFN3×2-6L

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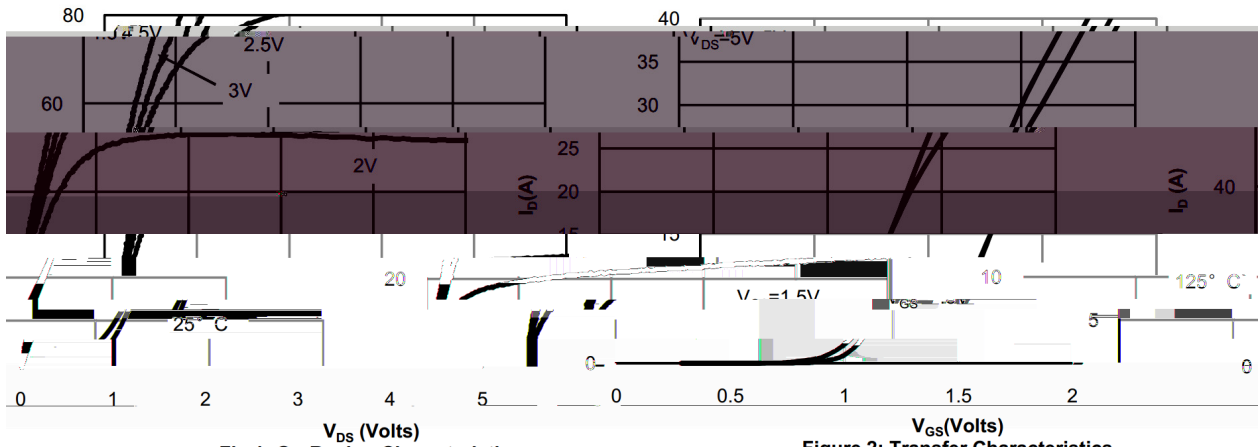


Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

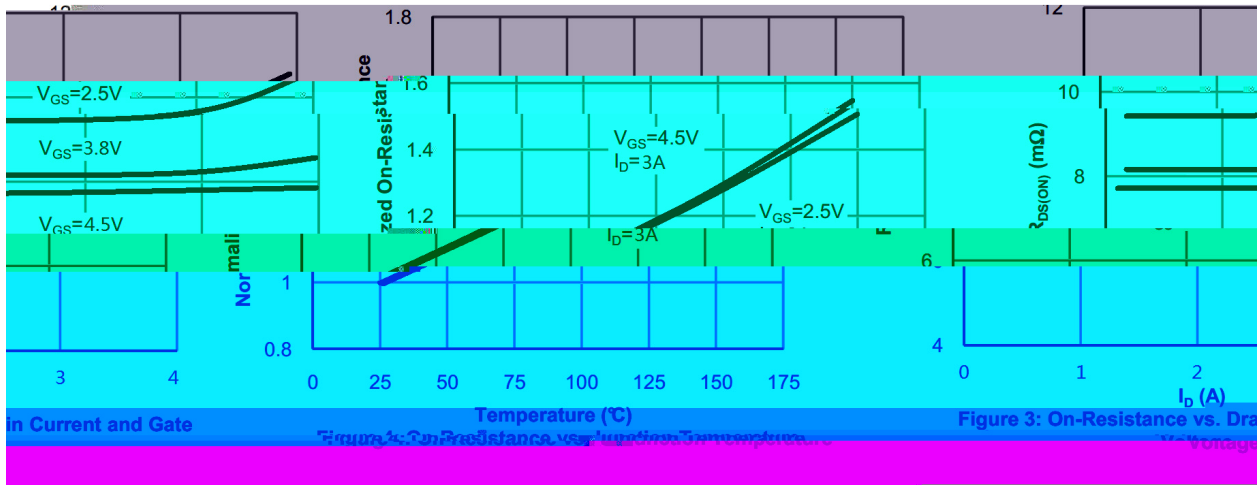


Figure 3: On-Resistance vs. Drain Current

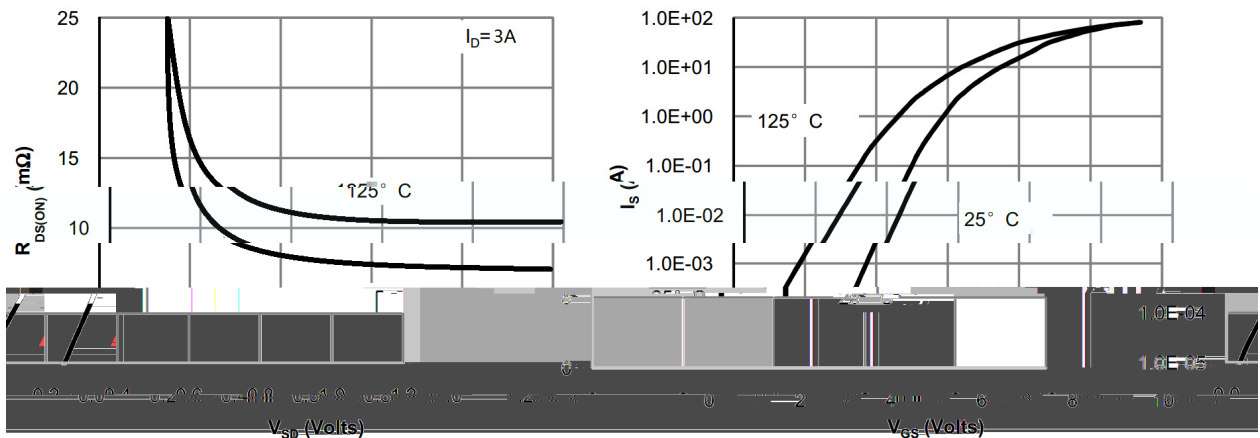


Figure 4: On-Resistance vs. Temperature

Figure 5: On-Resistance vs. Gate-Source Voltage

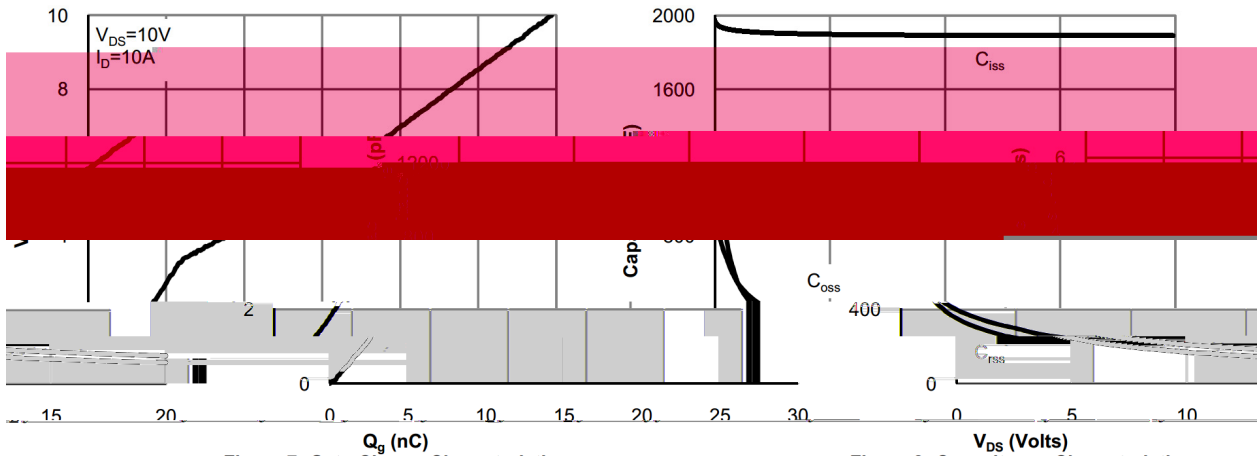
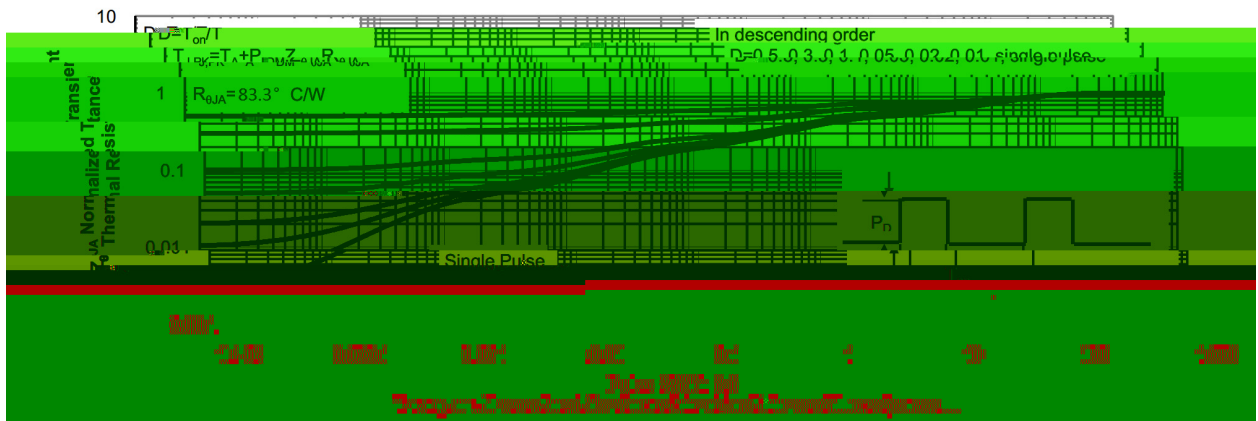
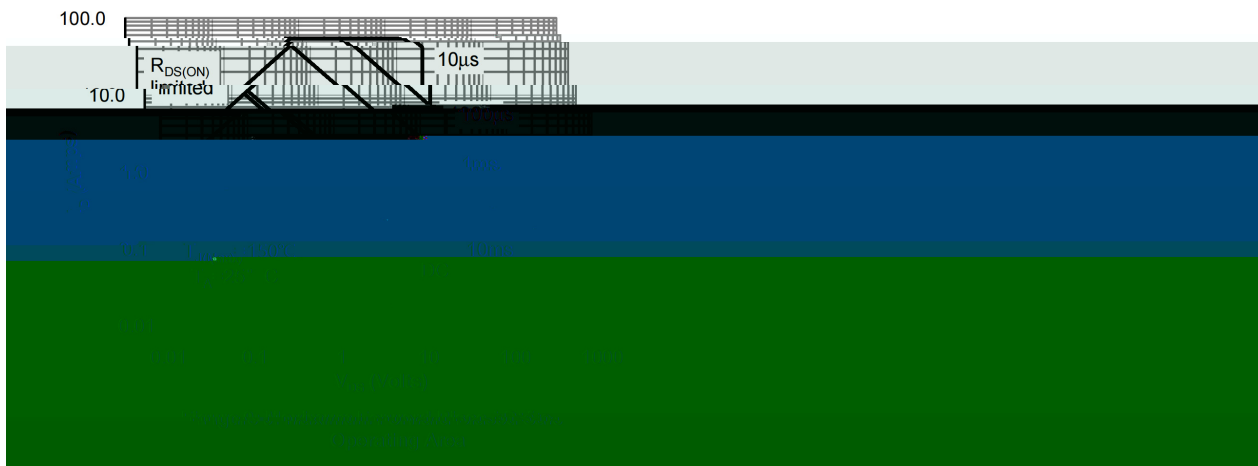


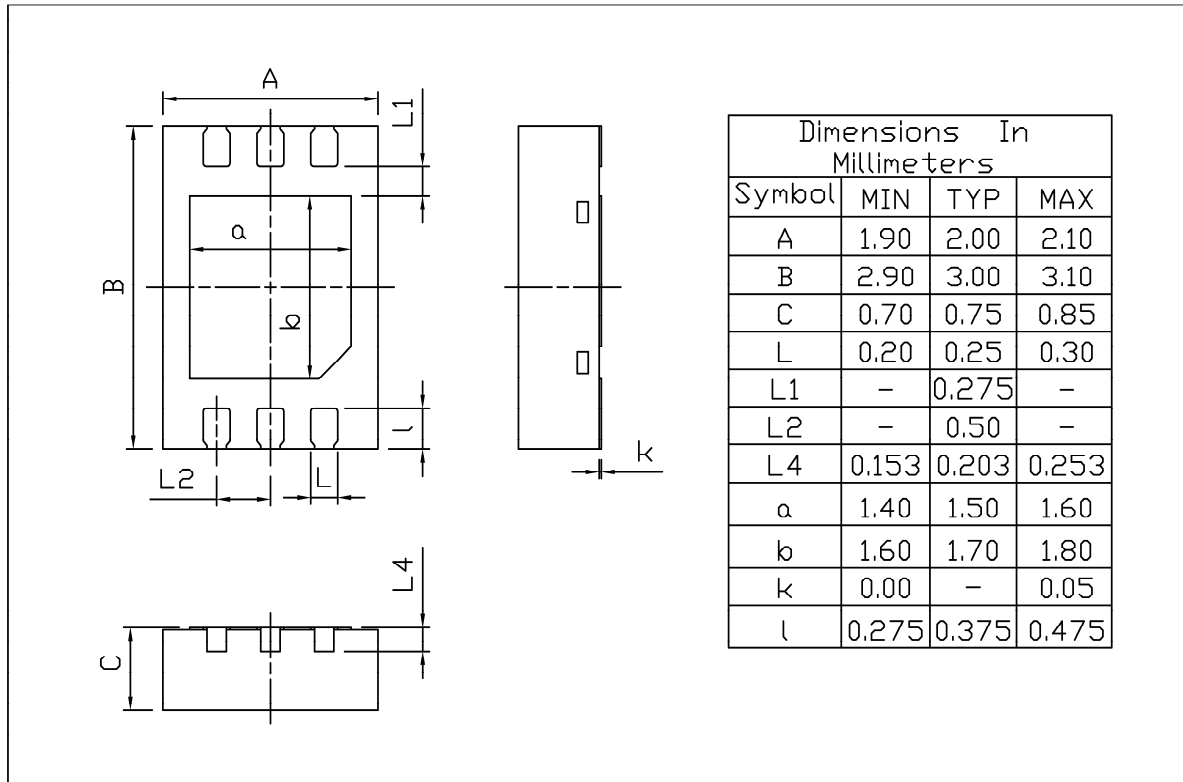
Figure 7: Gate Charge Characteristics

Figure 8: Capacitance Characteristics

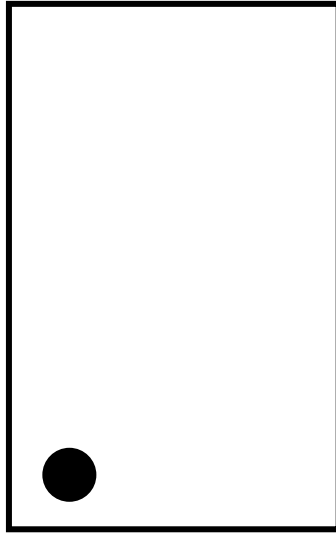


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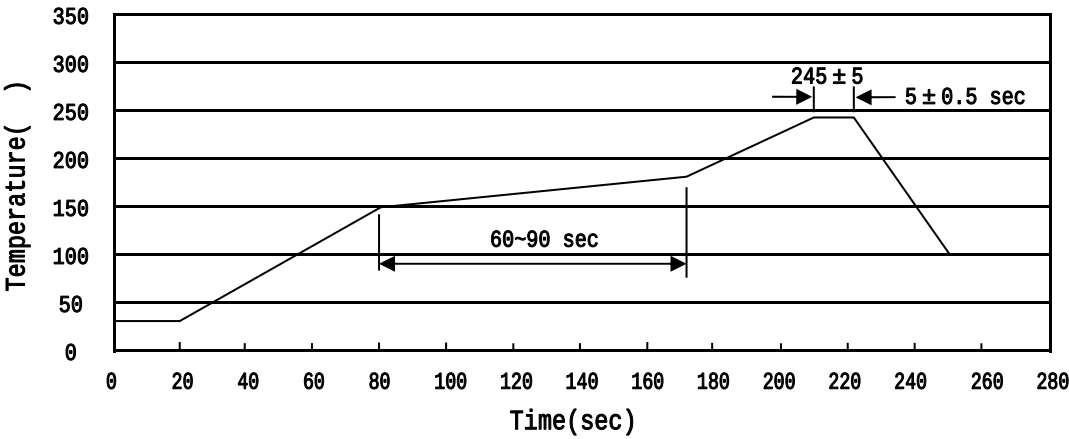
Unit:mm



Rev.00 202311



Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ± °C

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box